

ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE CODE	OPERATION TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
D0D4704DD	00 la a 1 00 0 D	0000	0500 1- 0500	D0D4704	DSD1794DB	Tube
DSD1794DB	28-lead SSOP	28DB	−25°C to 85°C	DSD1794	DSD1794DBR	Tape and reel

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

		DSD1794			
Complexable	V _{CC} 1, V _{CC} 2L, V _{CC} 2R	–0.3 V to 6.5 V			
Supply voltage	V _{DD}	−0.3 V to 4 V			
Supply voltage differen	ences: V _{CC} 1, V _{CC} 2L, V _{CC} 2R	±0.1 V			
Ground voltage differ	rences: AGND1, AGND2, AGND3L, AGND3R, DGND	±0.1 V			
Digital input voltage	PLRCK, PDATA, PBCK, SCK, RST, SCL, SDA(2), ADR0, ADR1, DSDL(2), DSDR(2), DBCK	−0.3 V to 6.5 V			
	DSDL(3), DSDR(3), SDA(3)	$-0.3 \text{ V to } (\text{V}_{\text{DD}} + 0.3 \text{ V}) < 4 \text{ V}$			
Analog input voltage		$-0.3 \text{ V to (V}_{CC} + 0.3 \text{ V}) < 6.5 \text{ V}$			
Input current (any pir	ns except supplies)	±10 mA			
Ambient temperature	under bias	-40°C to 125°C			
Storage temperature		−55°C to 150°C			
Junction temperature					
Lead temperature (so	260°C, 5 s				
Package temperature	e (IR reflow, peak)	250°C			

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

all specifications at $T_A = 25$ °C, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5$ V, $V_{DD} = 3.3$. V, $f_S = 44.1$ kHz, system clock = 256 f_S , and 24-bit data, unless otherwise noted

			1	DSD1794DB			
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
RES	OLUTION			24		Bits	
DAT	A FORMAT (PCM Mode)						
	Audio data interface format		Standa	rd, I ² S, left	justified		
	Audio data bit length		16-, 20-, 24-bit selectable				
	Audio data format		MSB first, 2s complement				
fs	Sampling frequency		10		200	kHz	
	System clock frequency		128, 192,	256, 384, 5	512, 768 f _S		
DAT	A FORMAT (DSD Mode)	•					
	Audio data interface format		DSD (d	lirect strear	n digital)		
	Audio data bit length			1 bit			
fs	Sampling frequency		2.8224			MHz	
	System clock frequency		2.8224		11.2896	MHz	

⁽²⁾ Input mode

⁽³⁾ Output mode



ELECTRICAL CHARACTERISTICS (Continued)

all specifications at $T_A = 25$ °C, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5$ V, $V_{DD} = 3.3$. V, $f_S = 44.1$ kHz, system clock = 256 f_S , and 24-bit data, unless otherwise noted

	242445752	TEGT CONDITIONS		DSD1794D	В	LINUT	
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
DIGIT	AL INPUT/OUTPUT				'		
	Logic family		-				
√IH			2			\/D0	
VIL	Input logic level				0.8	VDC	
IH	Investigation of the second	$V_{IN} = V_{DD}$			10		
IL	Input logic current	V _{IN} = 0 V			-10	μΑ	
/он	Outrot le sie level	I _{OH} = -2 mA	2.4			VDC	
OL	Output logic level	I _{OL} = 2 mA			0.4	VDC	
OYNA	MIC PERFORMANCE (PCM MODE, 2-V	RMS OUTPUT) (1)(2)					
		f _S = 44.1 kHz		0.0004%	0.0008%		
	THD+N at VOUT = 0 dB	f _S = 96 kHz		0.0008%			
		f _S = 192 kHz		0.0015%			
		EIAJ, A-weighted, fg = 44.1 kHz	123	127			
	Dynamic range	nic range EIAJ, A-weighted, f _S = 96 kHz 127					
		EIAJ, A-weighted, f _S = 192 kHz 127]	
		EIAJ, A-weighted, f _S = 44.1 kHz		127			
	Signal-to-noise ratio	EIAJ, A-weighted, fs = 96 kHz				dB	
		EIAJ, A-weighted, fg = 192 kHz					
		$f_S = 44.1 \text{ kHz}$ 120 123 $f_S = 96 \text{ kHz}$ 122		123			
	Channel separation				dB		
		f _S = 192 kHz					
	Level linearity error	V _{OUT} = −120 dB		±1		dB	
YNA	MIC PERFORMANCE (PCM Mode, 4.5-V	RMS Output) (1)(3)					
		f _S = 44.1 kHz		0.0004%			
	THD+N at VOUT = 0 dB	fs = 96 kHz		0.0008%			
		f _S = 192 kHz		0.0015%			
		EIAJ, A-weighted, fg = 44.1 kHz		129			
	Dynamic range	EIAJ, A-weighted, fg = 96 kHz		129		dB	
		EIAJ, A-weighted, fg = 192 kHz		129			
		EIAJ, A-weighted, fg = 44.1 kHz		129			
	Signal-to-noise ratio	EIAJ, A-weighted, $f_S = 96 \text{ kHz}$ 129 EIAJ, A-weighted, $f_S = 192 \text{ kHz}$ 129				dB	
		f _S = 44.1 kHz		124			
	Channel separation	f _S = 96 kHz		123		dB	
		f _S = 192 kHz					

⁽¹⁾ Filter condition:

THD+N: 20-Hz HPF, 20-kHz apogee LPF

Dynamic range: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted

Signal-to-noise ratio: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted

Channel separation: 20-Hz HPF, 20-kHz AES17 LPF

Analog performance specifications are measured using the System Two™ Cascade audio measurement system by Audio Precision™ in the averaging mode.

Other trademarks are the property of their respective owners.

⁽²⁾ Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 33.

⁽³⁾ Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 34.



ELECTRICAL CHARACTERISTICS (Continued)

all specifications at $T_A = 25^{\circ}C$, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5$ V, $V_{DD} = 3.3$. V, $f_S = 44.1$ kHz, system clock = 256 f_S , and 24-bit data, unless otherwise noted

DADAMETER	TEGT COMPLETIONS		SD1794D	В		
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OYNAMIC PERFORMANCE (MONO MODE) (1)	0(2)	•				
	f _S = 44.1 kHz		0.0004%			
THD+N at VOUT = 0 dB	$f_S = 96 \text{ kHz}$		0.0008%		1	
	f _S = 192 kHz		0.0015%		1	
	EIAJ, A-weighted, f _S = 44.1 kHz		132			
Dynamic range	EIAJ, A-weighted, f _S = 96 kHz		132		dB	
	EIAJ, A-weighted, f _S = 192 kHz		132			
	EIAJ, A-weighted, f _S = 44.1 kHz		132			
Signal-to-noise ratio	EIAJ, A-weighted, f _S = 96 kHz		132		dB	
	EIAJ, A-weighted, f _S = 192 kHz		132			
OSD MODE DYNAMIC PERFORMANCE (1) (3)	(44.1 kHz, 64 fg)					
THD+N at FS	4.5 V rms		0.0005%			
Dynamic range	-60 dB, EIAJ, A-weighted		128		dB	
Signal-to-noise ratio	EIAJ, A-weighted		128		dB	
ANALOG OUTPUT		•			•	
Gain error		-6	±2	6	% of FSI	
Gain mismatch, channel-to-channel		-3	±0.5	3	% of FSI	
Bipolar zero error	At BPZ	-2	±0.5	2	% of FSI	
Output current	Full scale (0 dB)		7.8		mA p-p	
Center current	At BPZ		-6.2		mA	
DIGITAL FILTER PERFORMANCE	·	•			•	
De-emphasis error				±0.004	dB	
ILTER CHARACTERISTICS-1: SHARP ROLLO	OFF					
	±0.00001 dB			0.454 fs		
Pass band	-3 dB			0.49 fs	İ	
Stop band		0.546 fs				
Pass-band ripple				±0.00001	dB	
Stop-band attenuation	Stop band = 0.546 fs	-130			dB	
Delay time			55/fs		s	
FILTER CHARACTERISTICS-2: SLOW ROLLO	FF	L				
	±0.04 dB			0.254 fs		
Pass band	-3 dB			0.46 f _S	1	
Stop band		0.732 fg				
Pass-band ripple				±0.001	dB	
Stop-band attenuation	Stop band = 0.732 fs	-100			dB	
Delay time			18/fs		S	

⁽¹⁾ Filter condition:

THD+N: 20-Hz HPF, 20-kHz apogee LPF

Dynamic range: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted

Signal-to-noise ratio: 20-Hz HPF, 20-kHz AES17 LPF, A-weighted

Channel separation: 20-Hz HPF, 20-kHz AES17 LPF

Analog performance specifications are measured using the System Two Cascade audio measurement system by Audio Precision in the averaging mode.

⁽²⁾ Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 34.

⁽³⁾ Dynamic performance and dc accuracy are specified at the output of the postamplifier as shown in Figure 35.



ELECTRICAL CHARACTERISTICS (Continued)

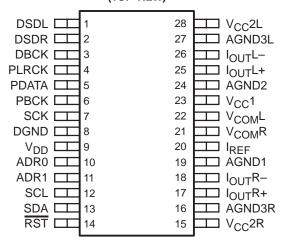
all specifications at $T_A = 25^{\circ}C$, $V_{CC}1 = V_{CC}2L = V_{CC}2R = 5$ V, $V_{DD} = 3.3$. V $f_S = 44.1$ kHz, system clock = 256 f_S , and 24-bit data, unless otherwise noted

24244552	TEST SOURITIONS		DSD1794D	В		
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
SUPPLY REQUIREMENTS					_	
		3	3.3	3.6	VDC	
Valta na van na						
Voltage range		4.75	5	5.25	VDC	
	f _S = 44.1 kHz		12	15		
(1)	f _S = 96 kHz		23		mA	
	f _S = 192 kHz		45]	
Supply current (1)	f _S = 44.1 kHz		33	40		
	f _S = 96 kHz		35		mA	
	f _S = 192 kHz		37]	
	f _S = 44.1 kHz		205	250		
Power dissipation (1)	f _S = 96 kHz	250			mW	
	f _S = 192 kHz	335			1	
RATURE RANGE					•	
Operation temperature		-25		85	°C	
Thermal resistance	28-pin SSOP		100		°C/W	
	Voltage range Supply current (1) Power dissipation (1) RATURE RANGE Operation temperature	SUPPLY REQUIREMENTS	SUPPLY REQUIREMENTS 3 3 4.75	PARAMETER TEST CONDITIONS MIN TYP SUPPLY REQUIREMENTS Voltage range 3 3.3 Voltage range 4.75 5 fs = 44.1 kHz 12 fs = 96 kHz 23 fs = 192 kHz 45 fs = 96 kHz 33 fs = 192 kHz 37 Fs = 192 kHz 37 Fs = 44.1 kHz 205 Fs = 96 kHz 250 fs = 192 kHz 335 RATURE RANGE -25	SUPPLY REQUIREMENTS 3 3.3 3.6	

⁽¹⁾ Input is BPZ data.

PIN ASSIGNMENTS

DSD1794 (TOP VIEW)





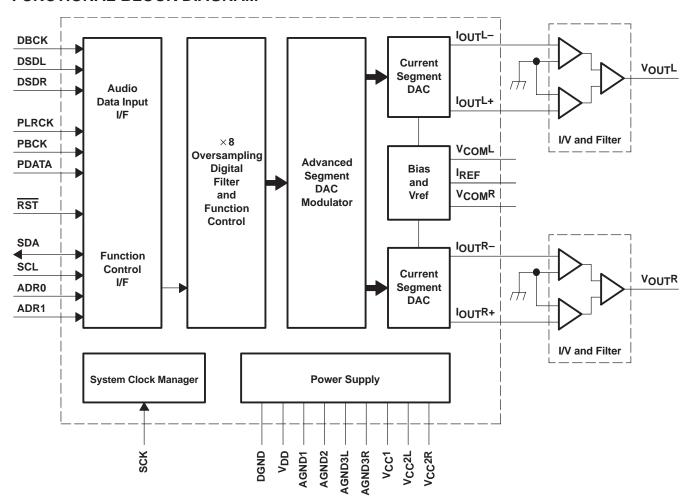
Terminal Functions

TERMI	NAL		
NAME	PIN	I/O	DESCRIPTIONS
ADR0	10	I	I ² C address 0 (1)
ADR1	11	I	I ² C address 1 (1)
AGND1	19	_	Analog ground (internal bias)
AGND2	24	_	Analog ground (internal bias)
AGND3L	27	_	Analog ground (L-channel DACFF)
AGND3R	16	-	Analog ground (R-channel DACFF)
DBCK	3	I	Bit clock input for DSD modes (1)
DGND	8	-	Digital ground
DSDL	1	I/O	L-channel audio data input when in DSD and external DF modes PCM-mode zero flag for L-channel when in zero-flag output mode (2)
DSDR	2	I/O	R-channel audio data input when in DSD and external DF modes (2) PCM-mode zero flag for R-channel when in zero-flag output mode
I _{OUT} L+	25	0	L-channel analog current output +
I _{OUT} L-	26	0	L-channel analog current output –
I _{OUT} R+	17	0	R-channel analog current output +
I _{OUT} R-	18	0	R-channel analog current output –
IREF	20	-	Output current reference bias pin
PBCK	6	I	Bit clock input. Connected to GND in DSD mode (1)
PDATA	5	I	Serial audio data input for PCM-format operation (1)
PLRCK	4	I	Left and right clock (fs) input for PCM-format operation. WDCK clock input for external DF mode. Connected to GND for DSD mode (1)
RST	14	I	Reset (1)
SCL	12	I	I ² C clock (1)
SCK	7	I	System clock input (1)
SDA	13	I/O	I ² C data (3)
V _{CC} 1	23	-	Analog power supply, 5 V
V _{CC} 2L	28	_	Analog power supply (L-channel DACFF), 5 V
V _{CC} 2R	15	-	Analog power supply (R-channel DACFF), 5 V
VCOML	22	-	L-channel internal bias decoupling pin
VCOMR	21	-	R-channel internal bias decoupling pin
V_{DD}	9	_	Digital power supply, 3.3 V

⁽¹⁾ Schmitt-trigger input, 5-V tolerant (2) Schmitt-trigger input and output. 5-V tolerant input, and CMOS output (3) Schmitt-trigger 5-V tolerant input and open-drain/3-state output



FUNCTIONAL BLOCK DIAGRAM

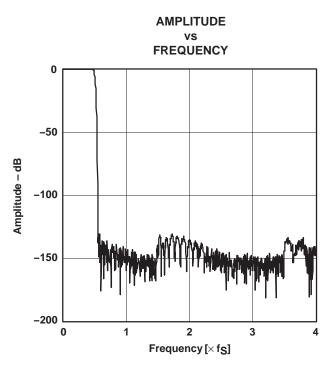




TYPICAL PERFORMANCE CURVES

DIGITAL FILTER

Digital Filter Response



AMPLITUDE
vs
FREQUENCY

0.000002

0.000001

0.000001

-0.000002

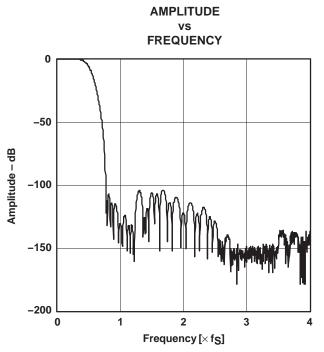
-0.000002

0.0 0.1 0.2 0.3 0.4 0.5

Frequency [×fs]

Figure 1. Frequency Response, Sharp Rolloff







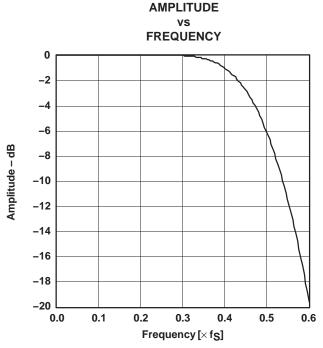
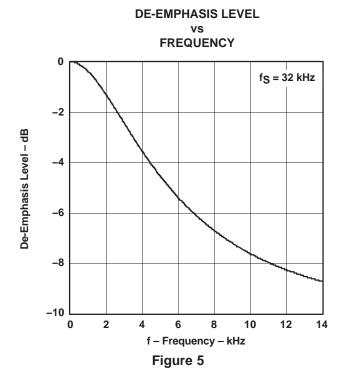
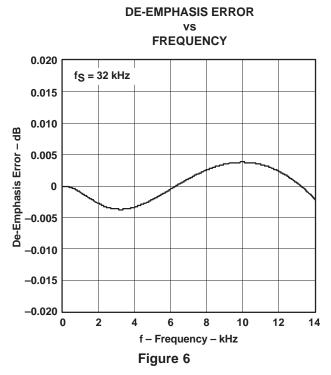


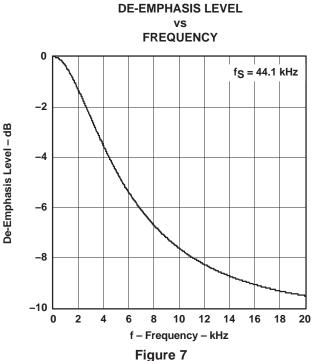
Figure 4. Transition Characteristics, Slow Rolloff

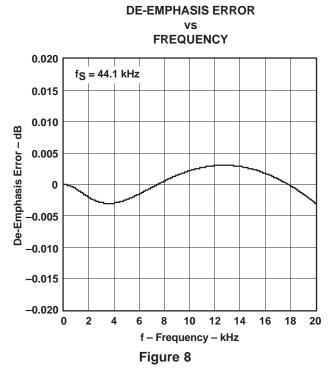


De-Emphasis Filter



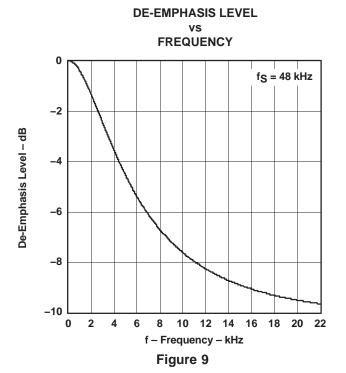


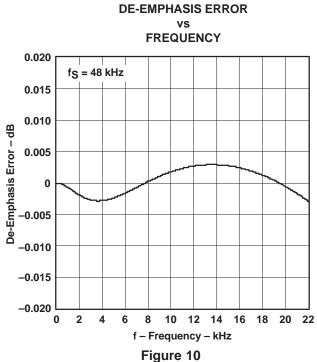






De-Emphasis Filter (Continued)

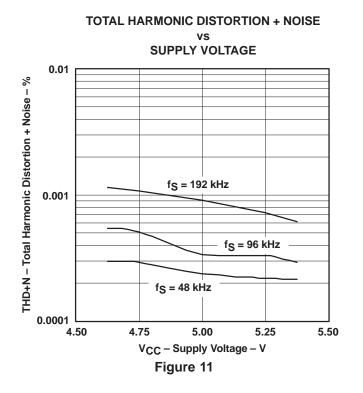


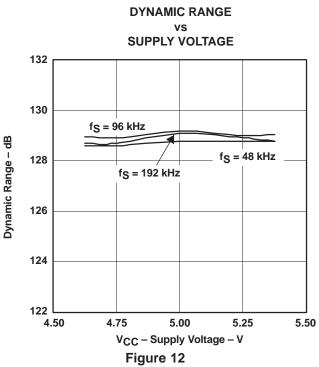


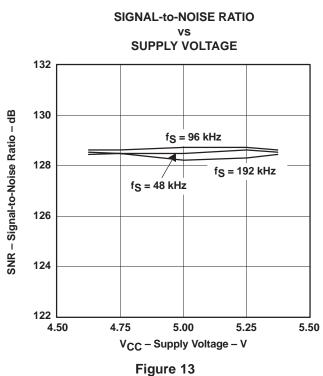


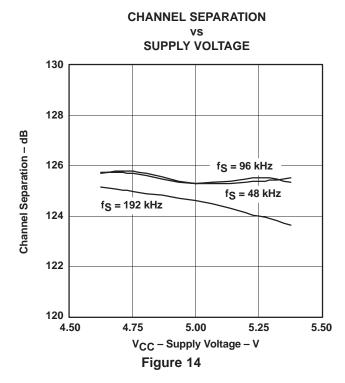
ANALOG DYNAMIC PERFORMANCE

Supply Voltage Characteristics





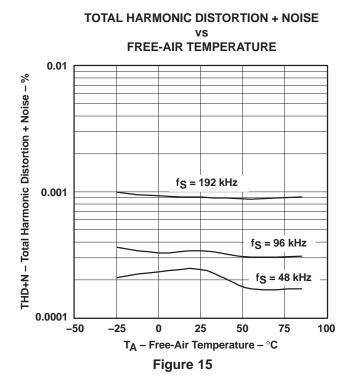


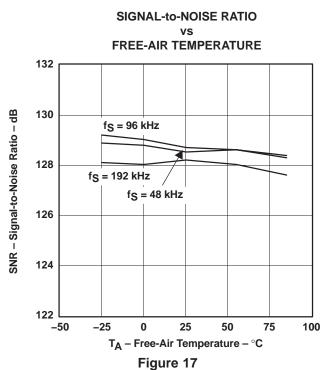


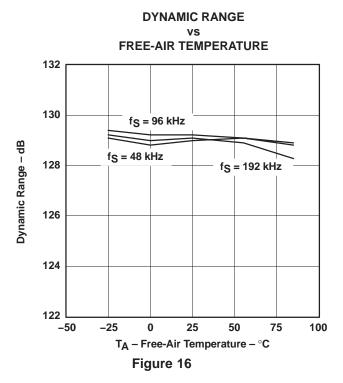
NOTE: PCM mode, $T_A = 25$ °C, $V_{DD} = 3.3$ V, measurement circuit is Figure 34 ($V_{OUT} = 4.5$ V rms).

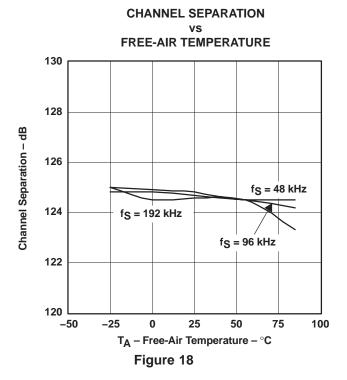


Temperature Characteristics



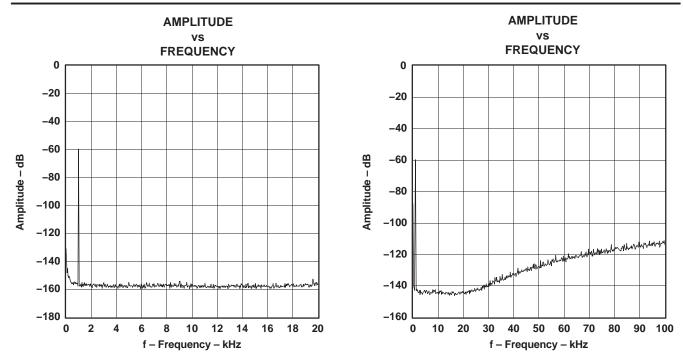






NOTE: PCM mode, V_{DD} = 3.3 V, V_{CC} = 5 V, measurement circuit is Figure 34 (V_{OUT} = 4.5 V rms).

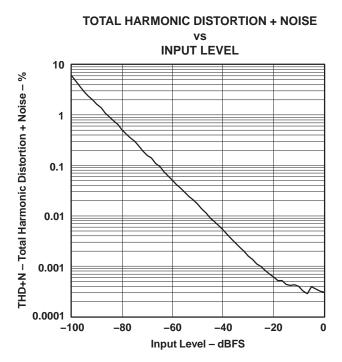




NOTE: PCM mode, $f_S = 48$ kHz, 32768 point 8 average, $T_A = 25^{\circ}\text{C}$, $V_{DD} = 3.3$ V, $V_{CC} = 5$ V, measurement circuit is Figure 34.

NOTE: PCM mode, $f_S = 48$ kHz, 32768 point 8 average, $T_A = 25$ °C, $V_{DD} = 3.3$ V, $V_{CC} = 5$ V, measurement circuit is Figure 34.

Figure 19. –60-db Output Spectrum, BW = 20 kHz Figure 20. –60-db Output Spectrum, BW = 100 kHz



NOTE: PCM mode, $f_S = 48$ kHz, $T_A = 25^{\circ}C$, $V_{DD} = 3.3$ V, $V_{CC} = 5$ V, measurement circuit is Figure 34.

Figure 21. THD+N vs Input Level, PCM Mode



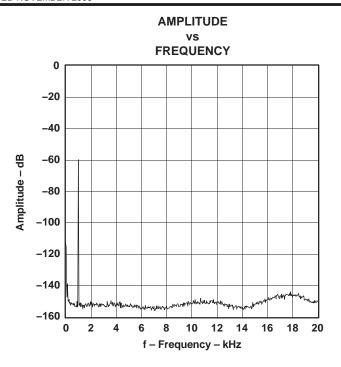


Figure 22. -60-dB Output Spectrum, DSD Mode

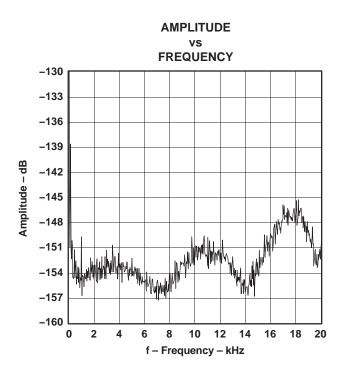


Figure 23. -150-dB Output Spectrum, DSD Mono Mode

NOTE: DSD mode (FIR-4), 32768 point 8 average, $T_A = 25^{\circ}C$, $V_{DD} = 3.3$ V, $V_{CC} = 5$ V, measurement circuit is Figure 35.



SYSTEM CLOCK AND RESET FUNCTIONS

System Clock Input

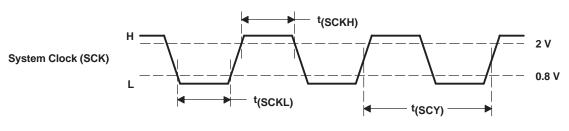
The DSD1794 requires a system clock for operating the digital interpolation filters and advanced segment DAC modulators. The system clock is applied at the SCK input (pin 7). The DSD1794 has a system clock detection circuit that automatically senses the frequency at which the system clock is operating. Table 1 shows examples of system clock frequencies for common audio sampling rates. If the oversampling rate of the delta-sigma modulator is selected as 128 f_S, the system clock frequency is required to be over 256 f_S.

Figure 24 shows the timing requirements for the system clock input. For optimal performance, it is important to use a clock source with low phase jitter and noise. One of the Texas Instruments PLL1700 family of multiclock generators is an excellent choice for providing the DSD1794 system clock.

CAMPLING EDECLIENCY	SYSTEM CLOCK FREQUENCY (fSCK) (MHz)								
SAMPLING FREQUENCY	128 f _S	192 f _S	256 f _S	384 f _S	512 f _S	768 f _S			
32 kHz	4.096(1)	6.144(1)	8.192	12.288	16.384	24.576			
44.1 kHz	5.6488(1)	8.4672	11.2896	16.9344	22.5792	33.8688			
48 kHz	6.144(1)	9.216	12.288	18.432	24.576	36.864			
96 kHz	12.288	18.432	24.576	36.864	49.152(1)	73.728(1)			
192 kHz	24.576	36.864	49.152(1)	73.728(1)	(2)	(2)			

Table 1. System Clock Rates for Common Audio Sampling Frequencies

⁽²⁾ This system clock rate is not supported for the given sampling frequency.



	PARAMETERS	MIN	MAX	UNITS
t(SCY)	System clock pulse cycle time	13		ns
t(SCKH)	System clock pulse duration, HIGH	0.4(SCY)		ns
t(SCKL)	System clock pulse duration, LOW	0.4(SCY)	·	ns

Figure 24. System Clock Input Timing

Power-On and External Reset Functions

The DSD1794 includes a power-on reset function. Figure 25 shows the operation of this function. With $V_{DD} > 2$ V, the power-on reset function is enabled. The initialization sequence requires 1024 system clocks from the time $V_{DD} > 2$ V. After the initialization period, the DSD1794 is set to its default reset state, as described in the *MODE CONTROL REGISTERS* section of this data sheet.

The DSD1794 also includes an external reset capability using the \overline{RST} input (pin 14). This allows an external controller or master reset circuit to force the DSD1794 to initialize to its default reset state.

Figure 26 shows the external reset operation and timing. The RST pin is set to logic 0 for a minimum of 20 ns. The RST pin is then set to a logic 1 state, thus starting the initialization sequence, which requires 1024 system clock periods. The external reset is especially useful in applications where there is a delay between the DSD1794 power up and system clock activation.

⁽¹⁾ This system clock rate is not supported in I²C fast mode.



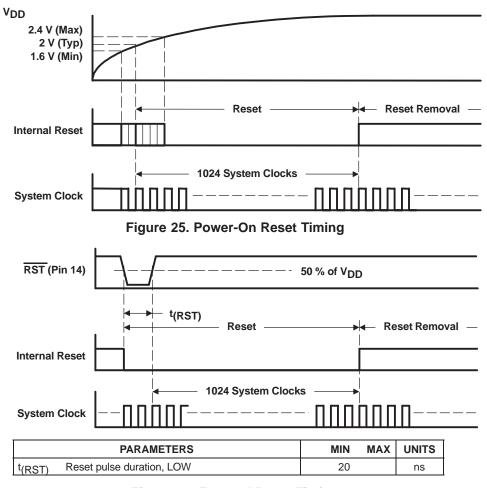


Figure 26. External Reset Timing



AUDIO DATA INTERFACE

Audio Serial Interface

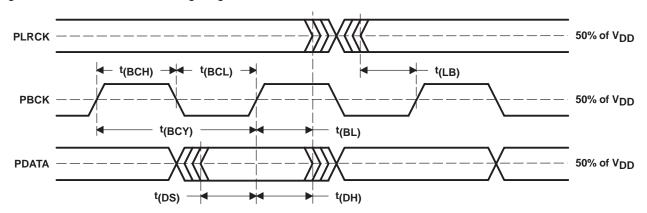
The audio interface port is a 3-wire serial port. It includes PLRCK (pin 4), PBCK (pin 6), and PDATA (pin 5). PBCK is the serial audio bit clock, and it is used to clock the serial data present on PDATA into the serial shift register of the audio interface. Serial data is clocked into the DSD1794 on the rising edge of PBCK. PLRCK is the serial audio left/right word clock.

The DSD1794 requires the synchronization of PLRCK and the system clock, but does not need a specific phase relation between PLRCK and the system clock.

If the relationship between PLRCK and the system clock changes more than ± 6 PBCK, internal operation is initialized within $1/f_S$ and analog outputs are forced to the bipolar zero level until resynchronization between PLRCK and the system clock is completed.

PCM Audio Data Formats and Timing

The DSD1794 supports industry-standard audio data formats, including standard right-justified, I²S, and left-justified. The data formats are shown in Figure 28. Data formats are selected using the format bits, FMT[2:0], in control register 18. The default data format is 24-bit I²S. All formats require binary twos-complement, MSB-first audio data. Figure 27 shows a detailed timing diagram for the serial audio interface.

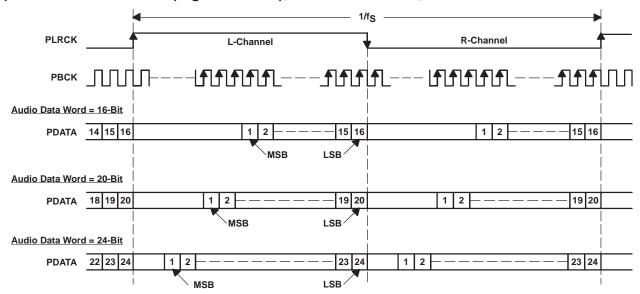


	PARAMETERS	MIN	MAX	UNITS
t(BCY)	PBCK pulse cycle time	70		ns
t(BCL)	PBCK pulse duration, LOW	30		ns
t(BCH)	PBCK pulse duration, HIGH	30		ns
t(BL)	PBCK rising edge to PLRCK edge	10		ns
t(LB)	PLRCK edge to PBCK rising edge	10		ns
t(DS)	PDATA Setup time	10		ns
t(DH)	PDATA hold time	10		ns
_	- PLRCK clock data 50% ± 2 bit c			

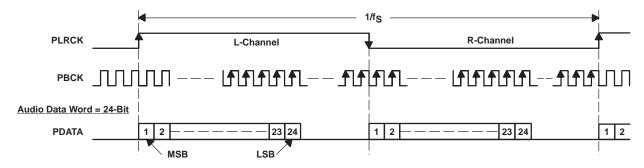
Figure 27. Timing of Audio Interface



(1) Standard Data Format (Right Justified); L-Channel = HIGH, R-Channel = LOW



(2) Left Justified Data Format; L-Channel = HIGH, R-Channel = LOW



(3) I²S Data Format; L-Channel = LOW, R-Channel = HIGH

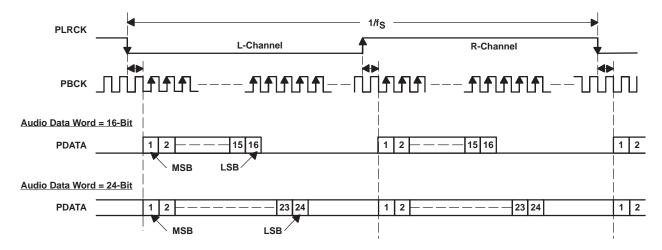


Figure 28. Audio Data Input Formats



External Digital Filter Interface and Timing

The DSD1794 supports an external digital filter interface with a 3- or 4-wire synchronous serial port, which allows the use of an external digital filter. External filters include the Texas Instruments DF1704 and DF1706, the Pacific Microsonics PMD200, or a programmable digital signal processor.

In the external DF mode, PLRCK (pin 4), PBCK (pin 6) and PDATA (pin 5) are defined as WDCK, the word clock; BCK, the bit clock; and DATA, the monaural data, respectively. The external digital filter interface is selected by using the DFTH bit of control register 20, which functions to bypass the internal digital filter of the DSD1794.

When the DFMS bit of control register 19 is set, the DSD1794 can process stereo data. In this case, DSDL (pin 1) and DSDR (pin 2) are defined as L-channel data and R-channel data input, respectively.

Detailed information for the external digital filter interface mode is provided in the APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE section of this data sheet.

Direct Stream Digital (DSD) Format Interface and Timing

The DSD1794 supports the DSD-format interface operation, which includes out-of-band noise filtering using an internal analog FIR filter. The DSD-format interface consists of a 3-wire synchronous serial port, which includes DBCK (pin 3), DSDL (pin 1), and DSDR (pin 2). DBCK is the serial bit clock. DSDL and DSDR are the L-channel and R-channel DSD data inputs, respectively. They are clocked into the DSD1794 on the rising edge of DBCK. PLRCK (pin 4) and PBCK (pin 6) are connected to GND in the DSD mode. The DSD-format interface is activated by setting the DSD bit of control register 20.

Detailed information for the DSD mode is provided in the APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE section of this data sheet.

SERIAL CONTROL INTERFACE (I²C)

The DSD1794 supports the I²C serial bus and the data transmission protocol for standard and fast mode as a slave device. This protocol is explained in I²C specification 2.0.

Slave Address

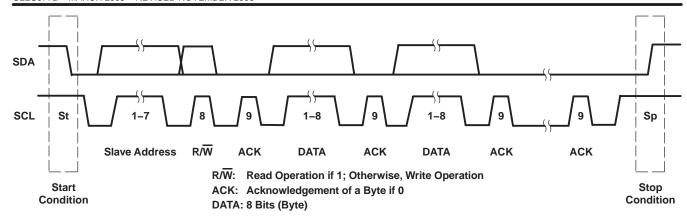
MSB							LSB	
1	0	0	1	1	ADR1	ADR0	R/W	Ī

The DSD1794 has 7 bits for its own slave address. The first five bits (MSBs) of the slave address are factory preset to 10011. The next two bits of the address byte are the device select bits which can be user-defined by the ADR1 and ADR0 terminals. A maximum of four DSD1794s can be connected on the same bus at one time. Each DSD1794 responds when it receives its own slave address.

Packet Protocol

A master device must control packet protocol, which consists of start condition, slave address, read/write bit, data if write or acknowledge if read, and stop condition. The DSD1794 supports only slave receivers and slave transmitters.





Write operation

Transmitter	М	М	М	S	М	S	М	S	 S	М
Data Type	St	Slave Address	R/W	ACK	DATA	ACK	DATA	ACK	 ACK	Sp

Read operation

Transmitter	М	М	М	S	S	М	S	М	 М	М
Data Type	St	Slave Address	R/W	ACK	DATA	ACK	DATA	ACK	 NACK	Sp

M: Master Device

S: Slave Device

St: Start Condition

Sp: Stop Condition

Figure 29. Basic I²C Framework

Write Register

A master can write to any DSD1794 registers using single or multiple accesses. The master sends a DSD1794 slave address with a write bit, a register address, and the data. If multiple access is required, the address is that of the starting register, followed by the data to be transferred. When the data are received properly, the index register is incremented by 1 automatically. When the index register reaches 0x7F, the next value is 0x0. When undefined registers are accessed, the DSD1794 does not send an acknowledgement. Figure 30 is a diagram of the write operation.

Transmitter	М	М	М	S	М	S	М	S	М	S	 S	М
Data Type	St	Slave Address	W	ACK	Reg Address	ACK	Write Data 1	ACK	Write Data 2	ACK	 ACK	Sp
	M: Master Device		S: SI	ave De	vice							
	St: Start Condition		W: V	/rite	ACK	: Ackno	owledge Sp:	Sp: Stop Condition				

Figure 30. Write Operation

Read Register

A master can read the DSD1794 register. The value of the register address is stored in an indirect index register in advance. The master sends a DSD1794 slave address with a read bit after storing the register address. Then the DSD1794 transfers the data which the index register points to. When the data are transferred during a multiple access, the index register is incremented by 1 automatically. (When first going into read mode immediately following a write, the index register is not incremented. The master can read the register that was previously written.) When the index register reaches 0x7F, the next value is 0x0. The DSD1794 outputs some data when the index register is 0x10 to 0x1F, even if it is not defined in Table 3. Figure 31 is a diagram of the read operation.



Transmitter	М	М	М	S	М	S	М	М	М	S	S	М	 М	М
Data Type	St	Slave Address	W	ACK	Reg Address	ACK	Sr	Slave Address	R	ACK	Data	ACK	 NACK	Sp

M: Master Device S: Slave Device

St: Start Condition Sr: Repeated Start Condition ACK: Acknowledge

Sp: Stop Condition NACK: Not Acknowledge W: Write R: Read

NOTE: The slave address after the repeat start condition must be the same as the previous slave address.

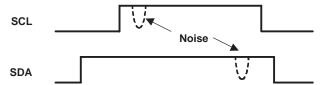
Figure 31. Read Operation

Noise Suppression

The DSD1794 incorporates noise suppression using the system clock (SCK). However, there must be no more than two noise spikes in 600 ns. The noise suppression works for SCK frequencies between 8 MHz and 40 MHz in fast mode. However, it works incorrectly in the following conditions.

Case 1:

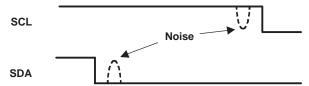
- 1. $t_{(SCK)} > 120 \text{ ns } (t_{(SCK)}: \text{ period of SCK})$
- 2. $t_{(HI)} + t_{(D-HD)} < t_{(SCK)} \times 5$
- 3. Spike noise exists on the first half of the SCL HIGH pulse.
- 4. Spike noise exists on the SDA HIGH pulse just before SDA goes LOW.



When these conditions occur at the same time, the data is recognized as LOW.

Case 2:

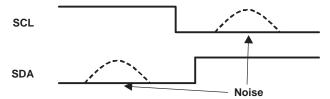
- 1. t(SCK) > 120 ns
- 2. $t_{(S-HD)}$ or $t_{(RS-HD)} < t_{(SCK)} \times 5$
- 3. Spike noise exists on both SCL and SDA during the hold time.



When these conditions occur at the same time, the DSD1794 fails to detect a start condition.

Case 3:

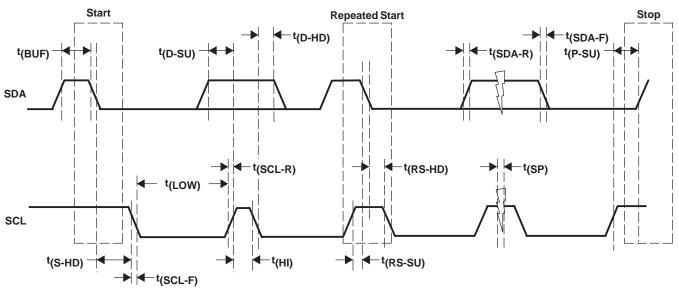
- 1. $t_{(SCK)} < 50 \text{ ns}$
- 2. $t_{(SP)} > t_{(SCK)}$
- 3. Spike noise exists on SCL just after SCL goes LOW.
- 4. Spike noise exists on SDA just before SCL goes LOW.



When these conditions occur at the same time, the DSD1794 erroneously detects a start or stop condition.



TIMING DIAGRAM



TIMING CHARACTERISTICS

	PARAMETER	CONDITIONS	MIN	MAX	UNIT
·	CCI algely framework	Standard		100	1-11-
f(SCL)	SCL clock frequency	Fast		400	kHz
·	Due free time between step and stept conditions	Standard	4.7		
t(BUF)	Bus free time between stop and start conditions	Fast	1.3		μs
	Low ported of the CCL clock	Standard	4.7		
(LOW)	Low period of the SCL clock	Fast	1.3		μs
	Lligh nation of the CCL plant	Standard	4		μs
(HI)	High period of the SCL clock	Fast	600		ns
	Catura time for (vancated) start condition	Standard	4.7		μs
(RS-SU)	Setup time for (repeated) start condition	Fast	600		ns
(S-HD)	Lold time for (reported) start condition	Standard	4		μs
(RS-HD)	Hold time for (repeated) start condition	Fast	600		ns
	Data catus tima	Standard	250		
(D-SU)	Data setup time	Fast	100		ns
	Data hald time	Standard	0	900	
(D-HD)	Data hold time	Fast	0	900	ns
	Disa time of CCI signal	Standard	20 + 0.1 C _B	1000	
(SCL-R)	Rise time of SCL signal	Fast	20 + 0.1 C _B	300	ns
	Rise time of SCL signal after a repeated start condition and after an	Standard	20 + 0.1 C _B	1000	
(SCL-R1)	acknowledge bit	Fast	20 + 0.1 C _B	300	ns
	Fall time of CCI signal	Standard	20 + 0.1 C _B	1000	
(SCL-F)	Fall time of SCL signal	Fast	20 + 0.1 C _B	300	ns
	Disa time of CDA signal	Standard	20 + 0.1 C _B	1000	
(SDA-R)	Rise time of SDA signal	Fast	20 + 0.1 C _B	300	ns
	Fall time of CDA signal	Standard	20 + 0.1 C _B	1000	
(SDA-F)	Fall time of SDA signal	Fast	20 + 0.1 C _B	300	ns
	Cotun time for stan condition	Standard	4		μs
(P-SU)	Setup time for stop condition	Fast	600		ns
^C (B)	Capacitive load for SDA and SCL line			400	pF
(SP)	Pulse duration of suppressed spike	Fast		50	ns
,		Standard			
VNН	Noise margin at high level for each connected device (including hysteresis)	Fast	0.2 V _{DD}		V



MODE CONTROL REGISTERS

User-Programmable Mode Controls

The DSD1794 includes a number of user-programmable functions which are accessed via mode control registers. The registers are programmed using the serial control interface, discussed in the SERIAL CONTROL INTERFACE (I^2C) section of this data sheet. Table 2 lists the available mode-control functions, along with their default reset conditions and associated register index.

Table 2. User-Programmable Function Controls

FUNCTION	DEFAULT	REGISTER	BIT	PCM	DSD	DF BYPASS
Digital attenuation control 0 dB to -120 dB and mute, 0.5 dB step	0 dB	Register 16 Register 17	ATL[7:0] (for L-ch) ATR[7:0] (for R-ch)	yes		
Attenuation load control—Disabled, enabled	Attenuation disabled	Register 18	ATLD	yes		
Input audio data format selection 16-, 20-, 24-bit standard (right-justified) format 24-bit MSB-first left-justified format 16-/24-bit I ² S format	24-bit I ² S format	Register 18	FMT[2:0]	yes		yes
Sampling rate selection for de-emphasis Disabled, 44.1 kHz, 48 kHz, 32 kHz	De-emphasis disabled	Register 18	DMF[1:0]	yes	yes(1)	
De-emphasis control—Disabled, enabled	De-emphasis disabled	Register 18	DME	yes		
Soft mute control—Mute disabled, enabled	Mute disabled	Register 18	MUTE	yes		
Output phase reversal—Normal, reverse	Normal	Register 19	REV	yes	yes	yes
Attenuation speed selection ×1 f _S , ×(1/2)f _S , ×(1/4)f _S , ×(1/8)f _S	×1 f _S	Register 19	ATS[1:0]	yes		
DAC operation control—Enabled, disabled	DAC operation enabled	Register 19	OPE	yes	yes	yes
Zero flag pin operation control DSD data input, zero flag output	DSD data input	Register 19	ZOE	yes		yes
Stereo DF bypass mode select Monaural, stereo	Monaural	Register 19	DFMS			yes
Digital filter rolloff selection Sharp rolloff, slow rolloff	Sharp rolloff	Register 19	FLT	yes		
Infinite zero mute control Disabled, enabled	Disabled	Register 19	INZD	yes		yes
System reset control Reset operation , normal operation	Normal operation	Register 20	SRST	yes	yes	yes
DSD interface mode control DSD enabled, disabled	Disabled	Register 20	DSD		yes	
Digital-filter bypass control DF enabled, DF bypass	DF enabled	Register 20	DFTH			yes
Monaural mode selection Stereo, monaural	Stereo	Register 20	MONO	yes	yes	yes
Channel selection for monaural mode data L-channel, R-channel	L-channel	Register 20	CHSL	yes	yes	yes
Delta-sigma oversampling rate selection ×64 f _S , ×128 f _S , ×32 f _S	×64 fs	Register 20	OS[1:0]	yes	yes(2)	yes
PCM zero output enable	Enabled	Register 21	PCMZ	yes		yes
DSD zero output enable	Disabled	Register 21	DZ[1:0]		yes	
Function available only for read	·	•	•	•	•	-
Zero detection flag Not zero, zero detected	Not zero = 0 Zero detected = 1	Register 22	ZFGL (for L-ch) ZFGR (for R-ch)	yes	yes	yes

⁽¹⁾ When in DSD mode, DMF[1:0] is defined as DSD filter (analog FIR) performance selection.

⁽²⁾ When in DSD mode, OS[1:0] is defined as DSD filter (analog FIR) operation rate selection.



Register Map

The mode control register map is shown in Table 3. Registers 16–21 include an R/\overline{W} bit, which determines whether a register read ($R/\overline{W} = 1$) or write ($R/\overline{W} = 0$) operation is performed. Register 22 is read-only.

Table 3. Mode Control Register Map

	B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	B5	B4	В3	B2	B1	В0
Register 16	R/W	0	0	1	0	0	0	0	ATL7	ATL6	ATL5	ATL4	ATL3	ATL2	ATL1	ATL0
Register 17	R/W	0	0	1	0	0	0	1	ATR7	ATR6	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0
Register 18	R/W	0	0	1	0	0	1	0	ATLD	FMT2	FMT1	FMT0	DMF1	DMF0	DME	MUTE
Register 19	R/W	0	0	1	0	0	1	1	REV	ATS1	ATS0	OPE	ZOE	DFMS	FLT	INZD
Register 20	R/W	0	0	1	0	1	0	0	RSV	SRST	DSD	DFTH	MONO	CHSL	OS1	OS0
Register 21	R/W	0	0	1	0	1	0	1	RSV	RSV	RSV	RSV	RSV	DZ1	DZ0	PCMZ
Register 22	R	0	0	1	0	1	1	0	RSV	RSV	RSV	RSV	RSV	RSV	ZFGR	ZFGL

Register Definitions

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	В3	B2	B1	B0
Register 16	R/W	0	0	1	0	0	0	0	ATL7	ATL6	ATL5	ATL4	ATL3	ATL2	ATL1	ATL0
Register 17	R/W	0	0	1	0	0	0	1	ATR7	ATR6	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0

R/W: Read/Write Mode Select

When $R/\overline{W} = 0$, a write operation is performed. When $R/\overline{W} = 1$, a read operation is performed.

Default value: 0

ATx[7:0]: Digital Attenuation Level Setting

These bits are available for read and write.

Default value: 1111 1111b

Each DAC output has a digital attenuator associated with it. The attenuator can be set from 0 dB to -120 dB, in 0.5-dB steps. Alternatively, the attenuator can be set to infinite attenuation (or mute).

The attenuation data for each channel can be set individually. However, the data load control (the ATLD bit of control register 18) is common to both attenuators. ATLD must be set to 1 in order to change an attenuator setting. The attenuation level can be set using the following formula:

Attenuation level (dB) = $0.5 \text{ dB} \cdot (ATx[7:0]_{DEC} - 255)$

where $ATx[7:0]_{DEC} = 0$ through 255

For $ATx[7:0]_{DEC} = 0$ through 14, the attenuator is set to infinite attenuation. Table 4 shows attenuation levels for various settings.

Table 4. Digital Attenuation Levels

ATx[7:0]	Decimal Value	Attenuation Level Setting
1111 1111b	255	0 dB, no attenuation (default)
1111 1110b	254	−0.5 dB
1111 1101b	253	−1.0 dB
:	:	i
0001 0000b	16	–119.5 dB
0000 1111b	15	–120.0 dB
0000 1110b	14	Mute
:	i	:
0000 0000b	0	Mute



	B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	B4	В3	B2	B1	В0
Register 18	R/W	0	0	1	0	0	1	0	ATLD	FMT2	FMT1	FMT0	DMF1	DMF0	DME	MUTE

R/W: Read/Write Mode Select

When $R/\overline{W} = 0$, a write operation is performed. When $R/\overline{W} = 1$, a read operation is performed.

Default value: 0

ATLD: Attenuation Load Control

This bit is available for read and write.

Default value: 0

ATLD = 0	Attenuation control disabled (default)
ATLD = 1	Attenuation control enabled

The ATLD bit is used to enable loading of the attenuation data contained in registers 16 and 17. When ATLD = 0, the attenuation settings remain at the previously programmed levels, ignoring new data loaded from registers 16 and 17. When ATLD = 1, attenuation data written to registers 16 and 17 is loaded normally.

FMT[2:0]: Audio Interface Data Format

These bits are available for read and write.

Default value: 101

For the external digital filter interface mode (DFTH mode), this register is operated as shown in the *Application for Interfacing With an External Digital Filter* section of this data sheet.

FMT[2:0]	Audio Data Format Selection
000	16-bit standard format, right-justified data
001	20-bit standard format, right-justified data
010	24-bit standard format, right-justified data
011	24-bit MSB-first, left-justified format data
100	16-bit I ² S-format data
101	24-bit I ² S-format data (default)
110	Reserved
111	Reserved

The FMT[2:0] bits are used to select the data format for the serial audio interface.

DMF[1:0]: Sampling Frequency Selection for the De-Emphasis Function

These bits are available for read and write.

Default value: 00

DMF[1:0]	De-Emphasis Sampling Frequency Selection
00	Disabled (default)
01	48 kHz
10	44.1 kHz
11	32 kHz

The DMF[1:0] bits are used to select the sampling frequency used by the digital de-emphasis function when it is enabled by setting the DME bit. The de-emphasis curves are shown in the *TYPICAL PERFORMANCE CURVES* section of this data sheet.

For the DSD mode, analog FIR filter performance can be selected using this register. A register map and filter response plots are shown in the *APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE* section of this data sheet.



DME: Digital De-Emphasis Control

This bit is available for read and write.

Default value: 0

DME = 0	De-emphasis disabled (default)
DME = 1	De-emphasis enabled

The DME bit is used to enable or disable the de-emphasis function for both channels.

MUTE: Soft Mute Control

This bit is available for read and write.

Default value: 0

MUTE = 0	MUTE disabled (default)
MUTE = 1	MUTE enabled

The MUTE bit is used to enable or disable the soft mute function for both channels.

Soft mute is operated as a 256-step attenuator. The speed for each step to $-\infty$ dB (mute) is determined by the attenuation rate selected in the ATS register.

	B15	B14	B13	B12	B11	B10	В9	B8	B7	B6	B5	B4	В3	B2	B1	В0
Register 19	R/W	0	0	1	0	0	1	1	REV	ATS1	ATS0	OPE	ZOE	DFMS	FLT	INZD

R/W: Read/Write Mode Select

When $R/\overline{W} = 0$, a write operation is performed.

When $R/\overline{W} = 1$, a read operation is performed.

Default value: 0

REV: Output Phase Reversal

This bit is available for read and write.

Default value: 0

REV = 0	Normal output (default)
REV = 1	Inverted output

The REV bit is used to invert the output phase for both channels.

ATS[1:0]: Attenuation Rate Select

These bits are available for read and write.

Default value: 00

ATS[1:0]	Attenuation Rate Selection
00	Every PLRCK (default)
01	PLRCK/2
10	PLRCK/4
11	PLRCK/8

The ATS[1:0] bits are used to select the rate at which the attenuator is decremented/incremented during level transitions.



OPE: DAC Operation Control

This bit is available for read and write.

Default value: 0

OPE = 0	DAC operation enabled (default)
OPE = 1	DAC operation disabled

The OPE bit is used to enable or disable the analog output for both channels. Disabling the analog outputs forces them to the bipolar zero level (BPZ) even if digital audio data is present on the input.

ZOE: Zero Flag Pin Operation Control

This bit is available for read and write.

Default value: 0

ZOE = 0	DSD data input (default)
ZOE = 1	Zero flag output

The ZOE bit is used to change the DSDL (pin 1) and DSDR (pin 2) pin assignments. When the ZOE bit is set to 0, DSDL and DSDR are inputs for L-channel and R-channel data. When the ZOE bit is set to 1, DSDL and DSDR become outputs for the L-channel and R-channel zero flags, respectively. See the PCMZ and DZ[1:0] bit descriptions of register 21.

DFMS: Stereo DF Bypass Mode Select

This bit is available for read and write.

Default value: 0

DFMS = 0	Monaural (default)
DFMS = 1	Stereo input enabled

The DFMS bit is used to enable stereo operation in DF bypass mode. In the DF bypass mode, when DFMS is set to 0, the pin for the input data is PDATA (pin 5) only, therefore the DSD1794 operates as a monaural DAC. When DFMS is set to 1, the DSD1794 can operate as a stereo DAC with inputs of L-channel and R-channel data on DSDL (pin 1) and DSDR (pin 2), respectively.

FLT: Digital Filter Rolloff Control

This bit is available for read and write.

Default value: 0

FLT = 0	Sharp rolloff (default)
FLT = 1	Slow rolloff

The FLT bit is used to select the digital filter rolloff characteristic. The filter responses for these selections are shown in the TYPICAL PERFORMANCE CURVES section of this data sheet.

INZD: Infinite Zero Detect Mute Control

This bit is available for read and write.

Default value: 0

INZD = 0	Infinite zero detect mute disabled (default)
INZD = 1	Infinite zero detect mute enabled

The INZD bit is used to enable or disable the zero detect mute function. Setting INZD to 1 forces muted analog outputs to hold a bipolar zero level when the DSD1794 detects zero data in both channels continuously for 1024 sampling periods (1/f_S). The infinite zero detect mute function does not work in the DSD mode.

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	B15	B14	B13	B12	B11	B10	В9	B8	B7	В6	B5	В4	В3	B2	B1	В0
Register 20	R/W	0	0	1	0	1	0	0	RSV	SRST	DSD	DFTH	MONO	CHSL	OS1	OS0

R/W: Read/Write Mode Select

When $R/\overline{W} = 0$, a write operation is performed. When $R/\overline{W} = 1$, a read operation is performed.

Default value: 0

SRST: System Reset Control

This bit is available for write only.

Default value: 0

SRST = 0	Normal operation (default)
SRST = 1	System reset operation (generate one reset pulse)

The SRST bit is used to reset the DSD1794 to the initial system condition.

DSD: DSD Interface Mode Control

This bit is available for read and write.

Default value: 0

DSD = 0	DSD interface mode disabled (default)
DSD = 1	DSD interface mode enabled

The DSD bit is used to enable or disable the DSD interface mode.

DFTH: Digital Filter Bypass (or Through Mode) Control

This bit is available for read and write.

Default value: 0

DFTH = 0	Digital filter enabled (default)
DFTH = 1	Digital filter bypassed for external digital filter

The DFTH bit is used to enable or disable the external digital filter interface mode.

MONO: Monaural Mode Selection

This bit is available for read and write.

Default value: 0

MONO = 0	Stereo mode (default)
MONO = 1	Monaural mode

The MONO function is used to change the operation mode from the normal stereo mode to the monaural mode. When the monaural mode is selected, both DACs operate in a balanced mode for one channel of audio input data. Channel selection is available for L-channel or R-channel data, determined by the CHSL bit as described immediately following.

CHSL: Channel Selection for Monaural Mode

This bit is available for read and write.

Default value: 0

This bit is available when MONO = 1.

CHSL = 0	L-channel selected (default)
CHSL = 1	R-channel selected

The CHSL bit selects L-channel or R-channel data to be used in monaural mode.



OS[1:0]: Delta-Sigma Oversampling Rate Selection

These bits are available for read and write.

Default value: 00

OS[1:0]	Operation Speed Select
00	64 times f _S (default)
01	32 times f _S
10	128 times f _S
11	Reserved

The OS bits are used to change the oversampling rate of delta-sigma modulation. Use of this function enables the designer to stabilize the conditions at the post low-pass filter for different sampling rates. As an application example, programming to set 128 times in 44.1-kHz operation, 64 times in 96-kHz operation, and 32 times in 192-kHz operation allows the use of only a single type (cutoff frequency) of post low-pass filter. The 128-f_S oversampling rate is not available at sampling rates above 100 kHz. If the 128-f_S oversampling rate is selected, a system clock of more than 256 f_S is required.

In DSD mode, these bits are used to select the speed of the bit clock for DSD data coming into the analog FIR filter.

	B15	B14	B13	B12	B11	B10	B9	B8	B7	B6	B5	B4	B3	B2	B1	B0
Register 21	R/W	0	0	1	0	1	0	1	RSV	RSV	RSV	RSV	RSV	DZ1	DZ0	PCMZ

R/W: Read/Write Mode Select

When $R/\overline{W} = 0$, a write operation is performed.

When $R/\overline{W} = 1$, a read operation is performed.

Default value: 0

DZ[1:0]: DSD Zero Output Enable

These bits are available for read and write.

Default value: 00

DZ[1:0]	Zero Output Enable
00	Disabled (default)
01	Even pattern detect
1x	96 _H pattern detect

The DZ bits are used to enable or disable the output zero flags, and to select the zero pattern in the DSD mode. The DSD1794 sets zero flags when the number of 1s and 0s are equal in every 8 bits of DSD input data, or the DSD input data is 1001 0110 continuously for 200 ms.

PCMZ: PCM Zero Output Enable

These bits are available for read and write.

Default value: 1

PCMZ = 0	PCM zero output disabled
PCMZ = 1	PCM zero output enabled (default)

The PCMZ bit is used to enable or disable the output zero flags in the PCM mode and the external DF mode. The DSD1794 sets the zero flags when the input data is continuously zero for 1024 LRCKs in the PCM mode or 1024 WDCKs in the external filter mode.

	B15	B14	B13	B12	B11	B10	B9	В8	B7	B6	B5	B4	В3	B2	B1	В0
Register 22	R	0	0	1	0	1	1	0	RSV	RSV	RSV	RSV	RSV	RSV	ZFGR	ZFGL



R: Read Mode Select

Value is always 1, specifying the readback mode.

ZFGx: Zero-Detection Flag

Where x = L or R, corresponding to the DAC output channel. These bits are available only for readback.

Default value: 00

ZFGx = 0	Not zero
ZFGx = 1	Zero detected

When the DSD1794 detects that audio input data is continuously zero, the ZFGx bit is set to 1 for the corresponding channel(s).

TYPICAL CONNECTION DIAGRAM

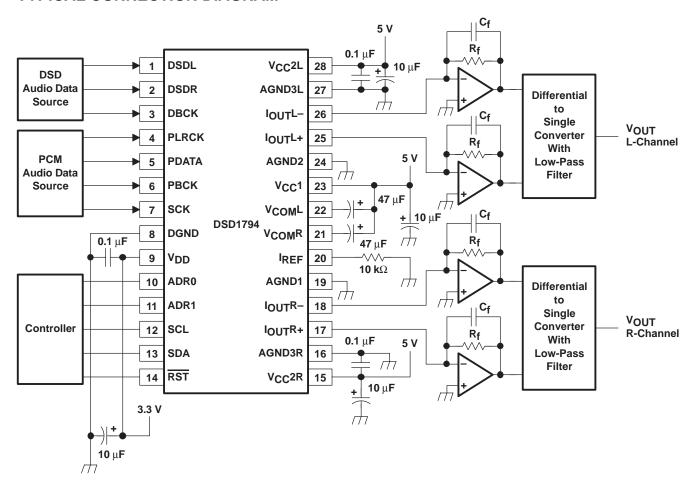


Figure 32. Typical Application Circuit



APPLICATION INFORMATION

APPLICATION CIRCUIT

The design of the application circuit is very important in order to actually realize the high S/N ratio of which the DSD1794 is capable. This is because noise and distortion that are generated in an application circuit are not negligible.

In the circuit of Figure 33, the output level is 2 V RMS and 127 dB S/N is achieved. The circuit of Figure 34 can realize the highest performance. In this case the output level is set to 4.5 V rms and 129 dB S/N is achieved (stereo mode). In monaural mode, if the output of the L-channel and R-channel is used as a balanced output, 132 dB S/N is achieved (see Figure 36).

Figure 35 shows a circuit for the DSD mode, which is a 4th-order LPF in order to reduce the out-of-band noise.

I/V Section

The current of the DSD1794 on each of the output pins (I_{OUT}L+, I_{OUT}L-, I_{OUT}R+, I_{OUT}R-) is 7.8 mA p-p at 0 dB (full scale). The voltage output level of the I/V converter (Vi) is given by following equation:

 $Vi = 7.8 \text{ mA p-p} \times R_f (R_f: \text{ feedback resistance of I/V converter})$

An NE5534 operational amplifier is recommended for the I/V circuit to obtain the specified performance. Dynamic performance such as the gain bandwidth, settling time, and slew rate of the operational amplifier affects the audio dynamic performance of the I/V section.

Differential Section

The DSD1794 voltage outputs are followed by differential amplifier stages, which sum the differential signals for each channel, creating a single-ended I/V op-amp output. In addition, the differential amplifiers provide a low-pass filter function.

The operational amplifier recommended for the differential circuit is the Linear Technology LT1028, because its input noise is low.



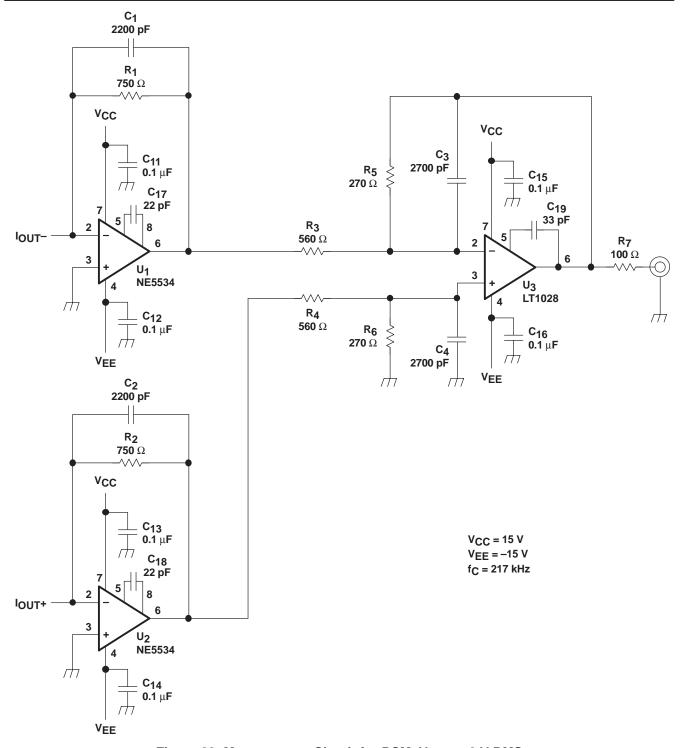


Figure 33. Measurement Circuit for PCM, V_{OUT} = 2 V RMS



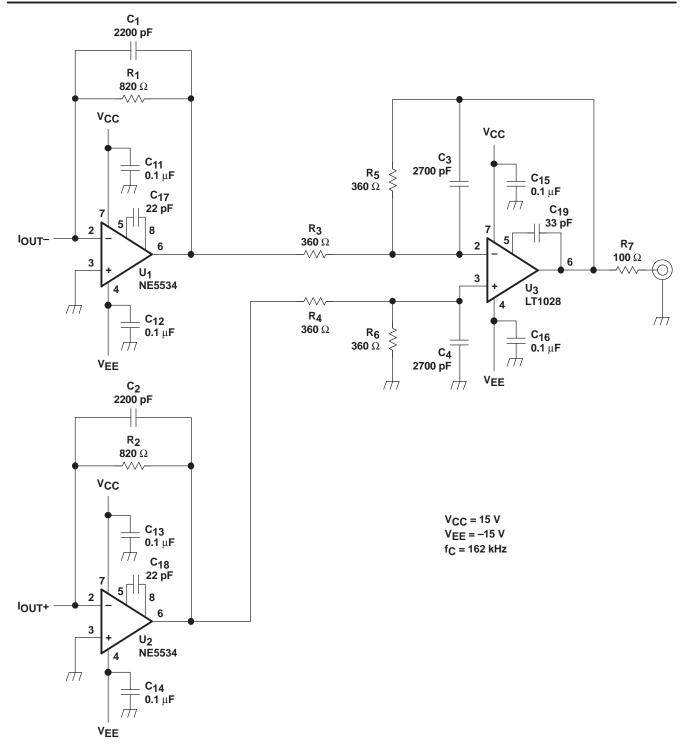


Figure 34. Measurement Circuit for PCM, V_{OUT} = 4.5 V RMS



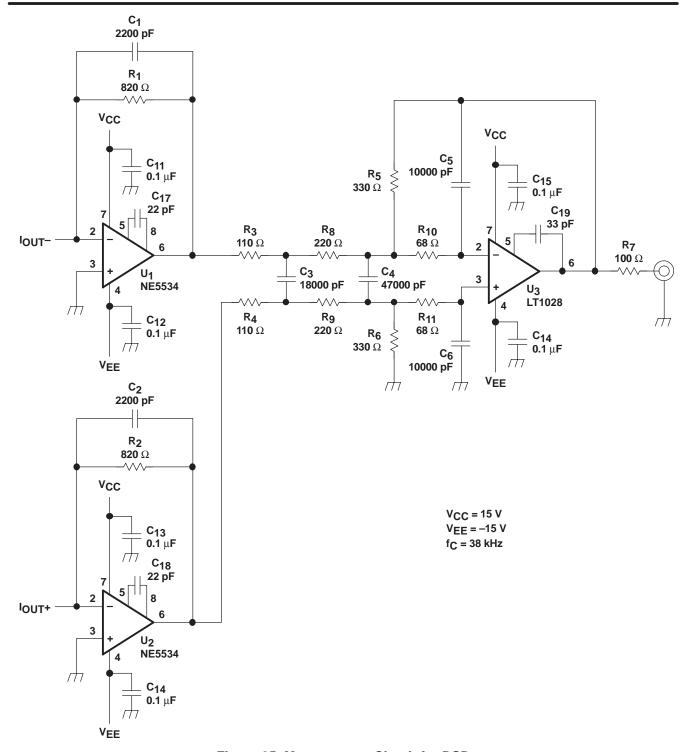


Figure 35. Measurement Circuit for DSD



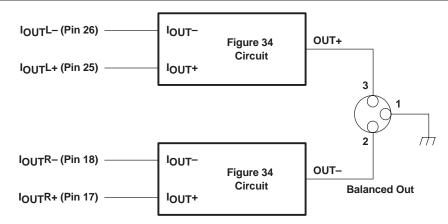


Figure 36. Measurement Circuit for Monaural Mode

APPLICATION FOR EXTERNAL DIGITAL FILTER INTERFACE

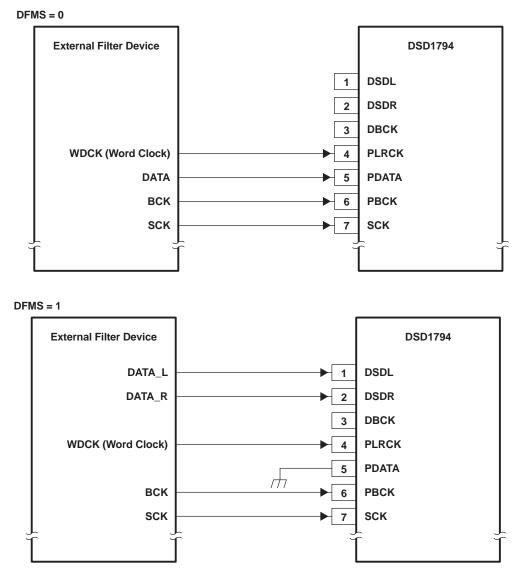


Figure 37. Connection Diagram for External Digital Filter (Internal DF Bypass Mode) Application



Application for Interfacing With an External Digital Filter

For some applications, it may be desirable to use an external digital filter to perform the interpolation function, as it can provide improved stop-band attenuation when compared to the internal digital filter of the DSD1794.

The DSD1794 supports several external digital filters, including:

- Texas Instruments DF1704 and DF1706
- Pacific Microsonics PMD200 HDCD filter/decoder IC
- Programmable digital signal processors

The external digital filter application mode is accessed by programming the following bit in the corresponding control register:

DFTH = 1 (register 20)

The pins used to provide the serial interface for the external digital filter are shown in the connection diagram of Figure 37. The word clock (WDCK) signal must be operated at $8\times$ or $4\times$ the desired sampling frequency, f_S .

System Clock (SCK) and Interface Timing

The DSD1794 in an application using an external digital filter requires the synchronization of WDCK and the system clock. The system clock is phase-free with respect to WDCK. Interface timing among WDCK, BCK, and DATA is shown in Figure 39.

Audio Format

The DSD1794 in the external digital filter interface mode supports right-justified audio formats including 16-bit, 20-bit, and 24-bit audio data, as shown in Figure 38. The audio format is selected by the FMT[2:0] bits of control register 18.

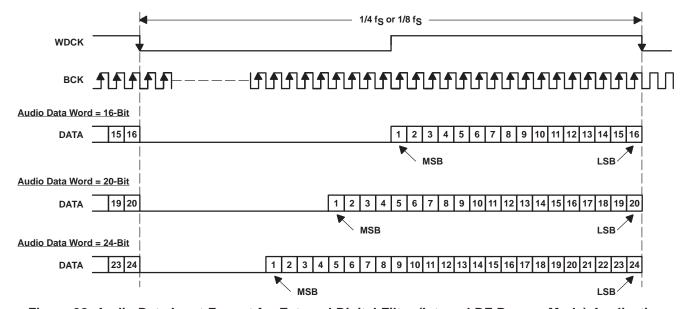


Figure 38. Audio Data Input Format for External Digital Filter (Internal DF Bypass Mode) Application



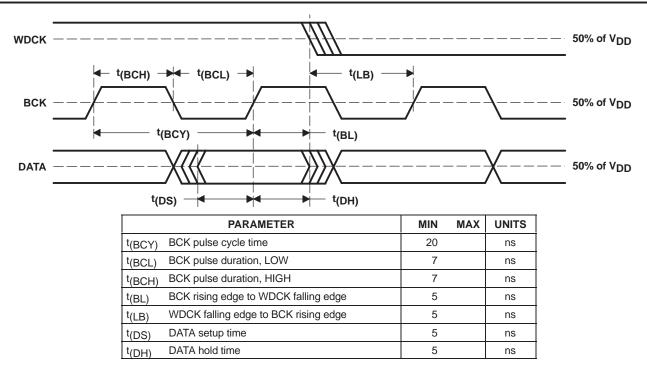


Figure 39. Audio Interface Timing for External Digital Filter (Internal DF Bypass Mode) Application

Functions Available in the External Digital Filter Mode

The external digital filter mode allows access to the majority of the DSD1794 mode control functions.

The following table shows the register mapping available when the external digital filter mode is selected, along with descriptions of functions which are modified when using this mode selection.

	B15	B14	B13	B12	B11	B10	В9	В8	В7	В6	B5	В4	В3	B2	B1	В0
Register 16	R/W	0	0	1	0	0	0	0	_	-	-	-	-	-	-	_
Register 17	R/W	0	0	1	0	0	0	1	-	-	-	-	-	-	-	_
Register 18	R/W	0	0	1	0	0	1	0	-	FMT2	FMT1	FMT0	-	-	-	_
Register 19	R/W	0	0	1	0	0	1	1	REV	-	-	OPE	_	DFMS	-	INZD
Register 20	R/W	0	0	1	0	1	0	0	-	SRST	0	1	MONO	CHSL	OS1	OS0
Register 21	R/W	0	0	1	0	1	0	1	_	-	-	-	-	_	-	PCMZ
Register 22	R	0	0	1	0	1	1	0	_	_	_	_	_	-	ZFGR	ZFGL

NOTE: 1 indicates that the bit is required for selection of external digital filter mode.

- indicates that function is disabled. No operation even if data bit is set

FMT[2:0]: Audio Data Format Selection

Default value: 000

FMT[2:0]	Audio Data Format Select
000	16-bit right-justified format (default)
001	20-bit right-justified format
010	24-bit right-justified format
Other	N/A



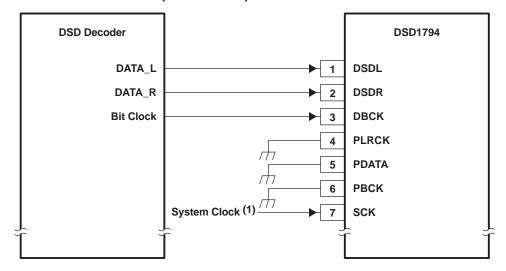
OS[1:0]: Delta-Sigma Modulator Oversampling Rate Selection

Default value: 00

OS[1:0]	Operation Speed Select
00	8 times WDCK (default)
01	4 times WDCK
10	16 times WDCK
11	Reserved

The effective oversampling rate is determined by the oversampling performed by both the external digital filter and the delta-sigma modulator. For example, if the external digital filter is $8\times$ oversampling, and the user selects OS[1:0] = 00, then the delta-sigma modulator oversamples by $8\times$, resulting in an effective oversampling rate of $64\times$. The $16\times$ WDCK oversampling rate is not available above a 100-kHz sampling rate. If the oversampling rate selected is $16\times$ WDCK, the system clock frequency must be over $256\,\mathrm{f}_\mathrm{S}$.

APPLICATION FOR DSD FORMAT (DSD MODE) INTERFACE



(1) The system clock is necessary for the initilaization sequence and the I²C interface operation.

Figure 40. Connection Diagram in DSD Mode

Feature

This mode is used for interfacing directly to a DSD decoder, which is found in Super Audio CD™ (SACD) applications.

The DSD mode is accessed by programming the following bit in the corresponding control register.

$$DSD = 1$$
 (register 20)

The DSD mode provides a low-pass filtering function to convert the 1-bit oversampled data stream to the analog domain. The filtering is provided using an analog FIR filter structure. Four FIR responses are available, and are selected by the DMF[1:0] bits of control register 18.

The DSD bit must be set before inputting DSD data, otherwise the DSD1794 erroneously detects the TDMCA mode, and commands are not accepted through the serial control interface.

Pin Assignment When DSD Format Interface

- DSDL (pin 1): L-channel DSD data input
- DSDR (pin 2): R-channel DSD data input
- DBCK (pin 3): Bit clock (BCK) for DSD data

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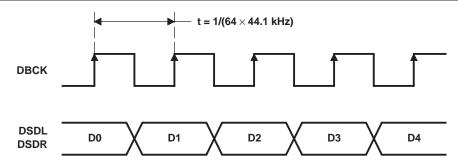
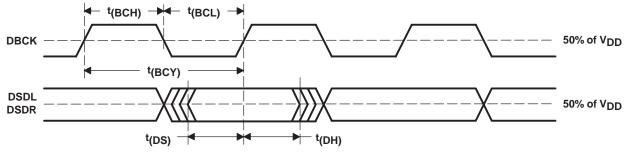


Figure 41. Normal Data Output Form From DSD Decoder



	PARAMETER	MIN	MAX	UNITS
t(BCY)	DBCK pulse cycle time	85(1)		ns
t(BCH)	DBCK high-level time	30		ns
t(BCL)	DBCK low-level time	30		ns
t(DS)	DSDL, DSDR setup time	10		ns
t(DH)	DSDL, DSDR hold time	10		ns

 $[\]overline{(1)}$ 2.8224 MHz × 4. (2.8224 MHz = 64 × 44.1 kHz. This value is specified as a sampling rate of DSD.)

Figure 42. Timing for DSD Audio Interface



1500

ANALOG FIR FILTER PERFORMANCE IN DSD MODE

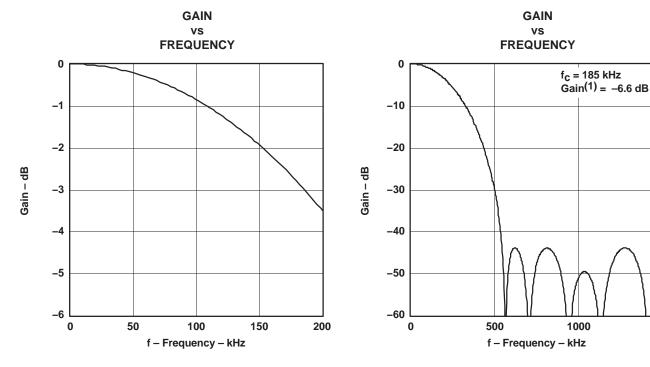
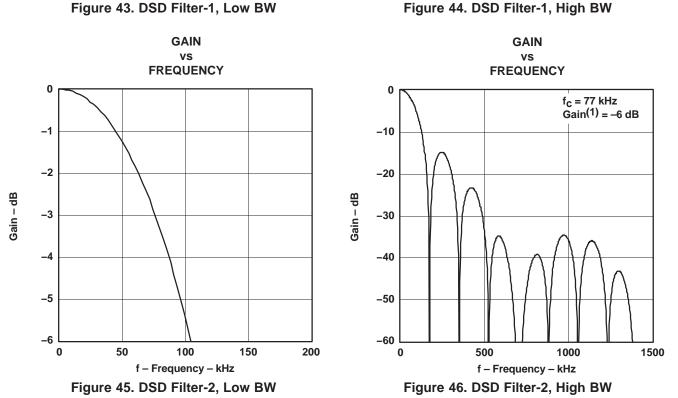


Figure 43. DSD Filter-1, Low BW



(1) This gain is in comparison to PCM 0 dB, when the DSD input signal efficiency is 50%.



ANALOG FIR FILTER PERFORMANCE IN DSD MODE (CONTINUED)

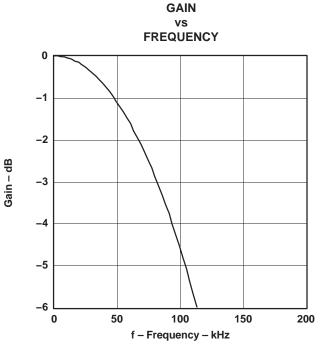


Figure 47. DSD Filter-3, Low BW

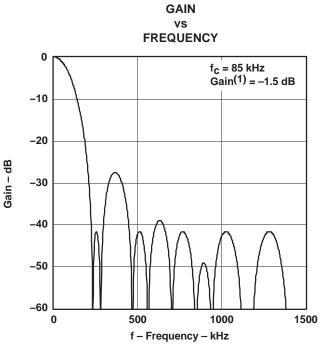


Figure 48. DSD Filter-3, High BW

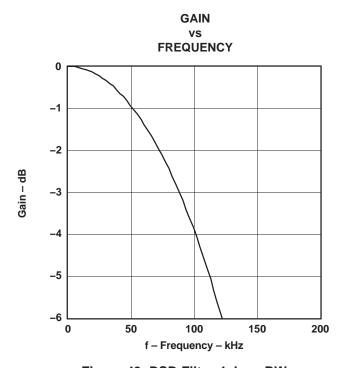


Figure 49. DSD Filter-4, Low BW

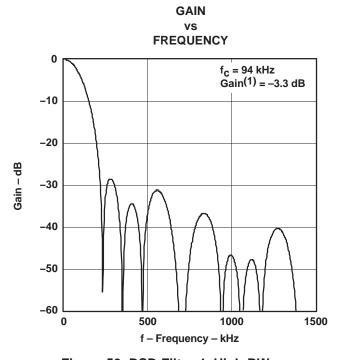


Figure 50. DSD Filter-4, High BW

(1) This gain is in comparison to PCM 0 dB, when the DSD input signal efficiency is 50%.



DSD MODE CONFIGURATION AND FUNCTION CONTROLS

Configuration for the DSD Interface Mode

DSD = 1 (Register 20, B5)

	B15	B14	B13	B12	B11	B10	В9	В8	В7	В6	B5	B4	В3	B2	B1	В0
Register 16	R/W	0	0	1	0	0	0	0	-	-	_	_	_	_	-	-
Register 17	R/W	0	0	1	0	0	0	1	-	-	-	-	_	-	-	-
Register 18	R/W	0	0	1	0	0	1	0	-	-	-	-	DMF1	DMF0	-	-
Register 19	R/W	0	0	1	0	0	1	1	REV	-	-	OPE	-	-	-	-
Register 20	R/W	0	0	1	0	1	0	0	-	SRST	1	-	MONO	CHSL	OS1	OS0
Register 21	R	0	0	1	0	1	0	1	-	-	-	-	_	DZ1	DZ0	-
Register 22	R	0	0	1	0	1	1	0	_	_	_	_	_	-	ZFGR	ZFGL

NOTE: - indicates that function is disabled. No operation even if data bit is set

DMF[1:0]: Analog FIR Performance Selection

Default value: 00

DMF[1:0]	Analog-FIR Performance Select
00	FIR-1 (default)
01	FIR-2
10	FIR-3
11	FIR-4

Plots for the four analog FIR filter responses are shown in the *TYPICAL PERFORMANCE CURVES* section of this data sheet.

OS[1:0]: Analog-FIR Operation-Speed Selection

Default value: 00

OS[1:0]	Operation Speed Select	
00	f _{DBCK} (default)	
01	f _{DBCK} /2	
10	Reserved	
11	f _{DBCK} /4	

The OS bit in the DSD mode is used to select the operating rate of the analog FIR. The OS bits must be set before setting the DSD bit to 1.

Requirements for System Clock

The bit clock (DBCK) for the DSD mode is required at pin 3 of the DSD1794. The frequency of the bit clock can be N times the sampling frequency. Generally, N is 64 in DSD applications.

The interface timing between the bit clock and DSDL and DSDR is required to meet the same setup-and hold-time specifications as shown in Figure 42.



THEORY OF OPERATION

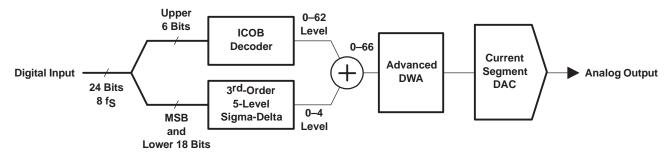


Figure 51. Advanced Segment DAC

The DSD1794 uses TI's advanced segment DAC architecture to achieve excellent dynamic performance and improved tolerance to clock jitter. The DSD1794 provides balanced current outputs.

Digital input data via the digital filter is separated into 6 upper bits and 18 lower bits. The 6 upper bits are converted to inverted complementary offset binary (ICOB) code. The lower 18 bits, associated with the MSB, are processed by a five-level third-order delta-sigma modulator operated at 64 f_S by default. The 1 level of the modulator is equivalent to the 1 LSB of the ICOB code converter. The data groups processed in the ICOB converter and third-order delta-sigma modulator are summed together to an up to 66-level digital code, and then processed by data-weighted averaging (DWA) to reduce the noise produced by element mismatch. The data of up to 66 levels from the DWA is converted to an analog output in the differential-current segment section.

This architecture has overcome the various drawbacks of conventional multibit processing and also achieves excellent dynamic performance.



Analog output

The following table and Figure 52 show the relationship between the digital input code and analog output.

	800000 (-FS)	000000 (BPZ)	7FFFFF (+FS)
I _{OUT} N [mA]	-2.3	-6.2	-10.1
IOUTP [mA]	-10.1	-6.2	-2.3
V _{OUT} N [V]	-1.725	-4.65	-7.575
V _{OUT} P [V]	-7.575	-4.65	-1.725
Vout [V]	-2.821	0	2.821

NOTE: V_{OUT}N is the output of U1, V_{OUT}P is the output of U2, and V_{OUT} is the output of U3 in the application circuit of Figure 33.

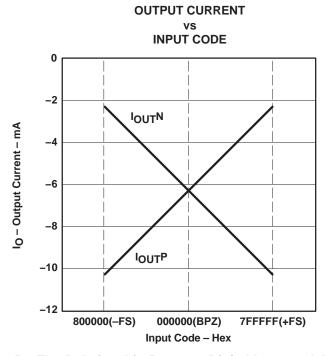


Figure 52. The Relationship Between Digital Input and Analog Output



PACKAGE OPTION ADDENDUM

17-May-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DSD1794DB	NRND	SSOP	DB	28	47	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		DSD1794	
DSD1794DBG4	NRND	SSOP	DB	28		TBD	Call TI	Call TI			

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

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OBSOLETE: TI has discontinued the production of the device.

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- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

17-May-2014

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DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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